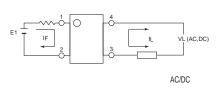
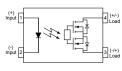
SUPSiC®

Parameter	Symbol	Rating	Units	
Load Voltage	VL	60	V	
Load Current	lL .	2	Α	
On-Resistance	Ron	0.069	Ω	
I/O Breakdown Voltage	V/IO	5000	Vrms	





- LED Anode
- 2. LED Cathode
- 3.4. Drain(MOS FET)



SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

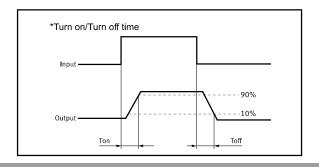
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Output r		rating				
Category	Category Load voltage Load current Package	Part No.	Packing quantity			
AC/DC	601/	0.4	DIP4	GAQY212G2E	100pcs/tube	
AC/DC 60V	2A	SMD4	GAQY212G2EH	2000pcs/1reel		



Rev 1.1

Jun.2016



Absolute Maximum Ratings (Ta = 25°C)

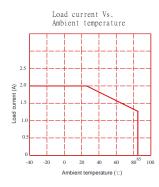
	Item	Symbol	Value	Units	Note
	Continuous LED Current	l _F	50	mA	
Input	Peak LED Current	l _{FP}	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	P _{In}	75	mW	
Output	Load Voltage	VL	60	V(AC peak or DC)	
	Load Current	lι	2.0	Α	
	Peak Load Current	Peak	6.0	А	100ms(1 pulse)
	Output Power Dissipation	Pout	500	mW	
Total Power	Dissipation	Рт	650	mW	
I/O Breakdo	own Voltage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating T	emperature	Торг	-40 to +85	°C	
Storage Temperature		T _{stg}	-40 to +100	°C	
Pin Solderir	ng Temperature	T _{sol}	260	°C	10 sec max.

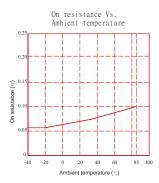
Electrical Specifications (Ambient Temperature: 25°C)

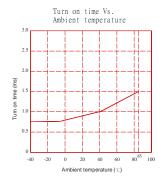
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	V _F	1.2	1.32	1.6	V	I⊧=10mA
Input	Operation LED Current	I _F on		1.0	5.0	mA	
	Recovery LED Current	I F off		0.35	0.5	mA	
	Recovery LED Voltage	V _{F off}	0.7			V	
Output	On-Resistance	Ron		0.069	0.12	Ω	I⊧=5mA,I∟=Max Time to flow is within 1 sec.
	Off-State Leakage Current	ILeak		0.1		uA	V _L =Rating
	Output Capacitance	Cout		115		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton	1.0	2.7	3.2	ms	I⊧=5mA, I∟=Max
sion	Turn-Off Time	Toff	0.04	0.05	0.1	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	5			GΩ	DC500V
Coupled	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

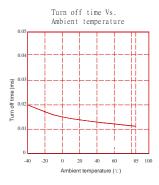
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

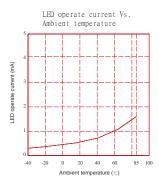
Engineering Data

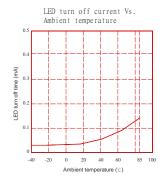


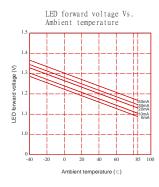


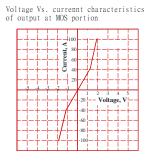


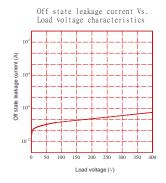


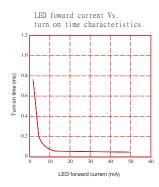


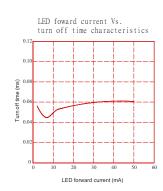


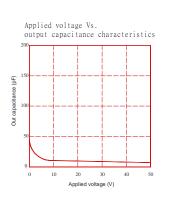




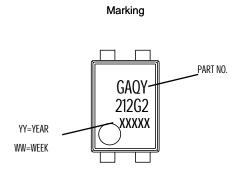


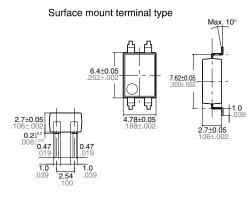






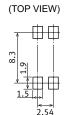
Dimensions and SMD-4 Package Unit: mm





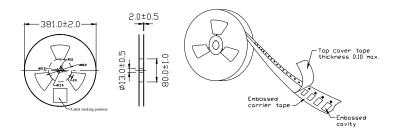
Terminal thickness: t = 0.2 General tolerance: ±0.1

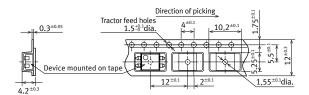
Recommended mounting pad



Tolerance: ±0.1

Tape dimensions (tape reel)





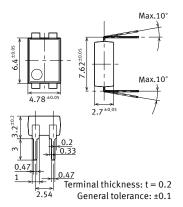


Dimensions and DIP-4 Package

Unit: mm

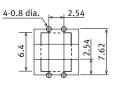
Marking GAOY 212G2 YY=YEAR WW=WEEK

Surface mount terminal type



PC board pattern

(BOTTOM VIEW)

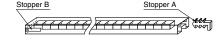


Tolerance: ±0.1

Tape dimensions (tape reel)

DIP type

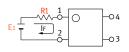
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.

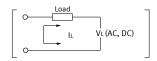




Using Methods

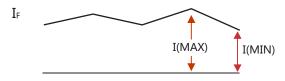
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

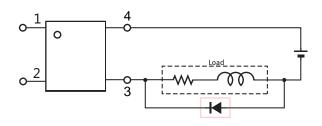
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

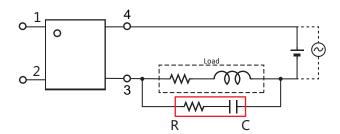
Protection Circuit

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

单击下面可查看定价,库存,交付和生命周期等信息

>>SUPSiC(国晶微)